

L Number	Hits	Search Text	DB	Time stamp
-	393	(385/18).CCLS.	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/28 16:30
-	2454	mems or microelectromechanical	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/18 15:54
-	1038	((mems or microelectromechanical) and (flap or plate))	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/18 15:54
-	428	((mems or microelectromechanical) and (flap or plate)) and base	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/18 15:54
-	190	((mems or microelectromechanical) and (flap or plate)) and base) and electrode	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/18 15:55
-	0	((mems or microelectromechanical) and (flap or plate)) and base) and (sidewall adj electrode)	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/18 15:55
-	27	((mems or microelectromechanical) and (flap or plate)) and base) and sidewall and electrode	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/18 15:55
-	883	385/17	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/03/28 16:31
-	45	385/17 and mems	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/04/01 08:05
-	49	385/17 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/04/01 09:59
-	63	385/18 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/04/01 13:09
-	14	359/872 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/04/01 13:19
-	1	359/876 and (mems or microelectromechanical)	USPAT; US-PGPUB; EPO; JPO; DEPVENT; IBM_TDB	2002/04/01 13:20

-	2	359/877 and (mems or microelectromechanical)	USPAT;	2002/04/01
			US-PGPUB;	13:23
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1	("6360036").PN.	USPAT;	2002/04/01
			US-PGPUB;	13:23
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	